Texas Instruments Inc. (DUNS# 00-732-1904) Supplier Name:

Contact Info:

ti.com/support
Distribute - RoHS and IEC 62474 DB Form/Declaration Type:

05/06/2022

## Details for "TLV2442CDR"

### **Current Product Information**

TI part number	Lead finish/Ball material	MSL rating/peak reflow	Assembly site	Package   Pins	Package body size (mm)	Total device mass (mg)*
TLV2442CDR	NIPDAU	Level-1-260C-UNLIM	TI TAIWAN A/T	D   8	3.91x4.9x1.58	84.9

The summary mass is a rounded value and will be within approximately +/- 10% of the detailed mass value.

## **Environmental Ratings Information**

RoHS	REACH	Green	IEC 62474 DB
Yes	Yes	Yes	Yes

## **Component Information**

				Homoge	neous Material Level	Component Level	
Component	Substance	CAS Number	Amount (mg)	Percentage %	ppm	Percentage %	ppm
Bond Wire							
Other Nonferrous Metals and Alloys	Yttrium	7440-65-5	0.000001	0.001284	13	0.000001	0
Precious Metals	Gold	7440-57-5	0.0779	99.997433	999974	0.091732	917
Precious Metals	Silver	7440-22-4	0.000001	0.001284	13	0.000001	0
Sub-Total			0.077902	100	1000000	0.091735	917
Die Attach Adhesive							
Precious Metals	Silver	7440-22-4	0.385687	79.999959	800000	0.454171	4542
Thermoplastics	Epoxy	85954-11-6	0.096422	20.000041	200000	0.113543	1135
Sub-Total			0.482109	100	1000000	0.567714	5677
Lead Frame							
Copper and Its Alloys	Copper	7440-50-8	24.25509	97.41	974100	28.561909	285619
Copper and Its Alloys	Iron	7439-89-6	0.5976	2.4	24000	0.703712	7037
Copper and Its Alloys	Phosphorus	7723-14-0	0.00747	0.03	300	0.008796	88
Other Nonferrous Metals and Alloys	Lead	7439-92-1	0.00747	0.03	300	0.008796	88
Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.00747	0.03	300	0.008796	88
Zinc and Its Alloys	Zinc	7440-66-6	0.0249	0.1	1000	0.029321	293
Sub-Total			24.9	100	1000000	29.321332	293213
Lead Frame Plating							
Nickel and Its Alloys	Nickel	7440-02-0	0.355273	95.119946	951199	0.418357	4184
Precious Metals	Gold	7440-57-5	0.002913	0.77992	7799	0.00343	34
Precious Metals	Palladium	7440-05-3	0.015314	4.100134	41001	0.018033	180
Sub-Total			0.3735	100	1000000	0.43982	4398
Mold Compound	•	*			•	•	
Other Inorganic Materials	Fused Silica	60676-86-0	50.610118	88.000001	880000	59.596629	595966
Other Plastics and Rubber	Carbon Black	1333-86-4	0.172534	0.299999	3000	0.20317	2032
Other Plastics and Rubber	Organic Phosphorus	1330-78-5	0.316313	0.55	5500	0.372479	3725
Thermoplastics	Ероху	85954-11-6	6.412532	11.15	111500	7.551164	75512
Sub-Total			57.511497	100	1000000	67.723442	677234
Semiconductor Device		-			-	-	
Ceramics / Glass	Doped Silicon	7440-21-3	1.5761	100	1000000	1.855958	18560
Sub-Total			1.5761	100	1000000	1.855958	18560
Total			84.921108			100	1000000

The ppm calculations are at the homogeneous material level and are maximum concentration values. The ppm displayed represents the homogeneous material with the highest ppm for that substance. The amount (mg) calculations represent the maximum total amount of each substance within the component.

The ppm calculations are at the component level and are average concentration values. The amount (mg) calculations represent the average total amount of each substance within the component.

# See Glossary of Terms for more details.

There is a remote possibility the Customer Part Number (CPN) your company uses could reference more than one TI part number. This is due to two or more users (EMSIs or subcontractors) using the same CPN for different TI part numbers. If this occurs, please check your Customer Part Number and cross reference it with the TI part number seen on this page.

# **Product Content Methodology**

For an explanation of the methods used to determine material weights, See Product Content Methodology

## Material Declaration Certificate for Semiconductor IC Packaged Products

TI certifies that the material content information provided by TI is representative and accurate to the best of their knowledge based on material information provided by its suppliers and their combination into finished IC packaged products. TI semiconductor products designated to be "Pb-free", "Green" or "RoHS Exempt" fully meets the latest EU RoHS Directive requirements along with other legislation as seen in the former JIG-101 list that has been transferred to the IEC 62474 database.

# Important Information/Disclaimer

Tibases its material content information on information provided by third-party suppliers and has taken, and continues to take, reasonably diligent steps to provide any required or available information. TI may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. Tl and Tl suppliers may consider certain information to be proprietary, and thus certain information may not be available for release by Tl. The material content information is

For additional information, please contact TI customer support.

Signature: (click here for a fuller statement with a signed certificate)

Name/Title: Hubie Payne, Vice President, Worldwide SC Quality For further environmental statements, please go to www.ti.com/ecoinfo Created on: 05/06/2022

ROHS: Means TI semiconductor products that are compliant with the current ROHS requirement that the maximum concentration values of the ten substances listed in ROHS Annex II do not exceed 0.1 % by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI semiconductor products labeled as "RoHS Compliant" are suitable for use in specified lead-free processes. TI may also reference these types of semiconductor products as "Pb-Free." These TI semiconductor products are also fully compliant with GADSL and the IEC 62474 database for electronic requirements.

RoHS Exempt: Means TI semiconductor products that contain lead (Pb) above the RoHS Annex II threshold, but that fall within one of the specific RoHS exemptions noted above or documented in http://www.ti.com/lit/pdf/szzq088

Green: Means the content of Chlorine (CI) and Bromine (Br)-based flame retardants meet JS709B low halogen requirements of <=1 000ppm threshold; Antimony trioxide (5b203) contained in halogen based flame retardant materials meets the <=1 000ppm threshold requirement; and Beryllium Oxide (BeO) is <=1000ppm.